ABBOGIATION CONNECTING ELECTRONICS INDUSTRIES®	kburn. Illinois. A	All rights reserved untions.	Inder both	This docume level parts, t	ent is a declarat	ion of the s encompasse	ubstances s all lowe	within the man r level material	ufacturer liste s for which th	ed item. Note e manufactu	e: if the item is an a rrer has engineering	ssembly with lower responsibility.	
IPC Web Site for Information or http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard         Form Typ           http://www.ipc.org/IPC-175x         Distributor				<ul> <li>Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Material</li> </ul>					ls and Mfg Information			
Supplier Information													
Company name* Company unique ID				Unique ID Authority					Resp	Response Date*			
onsemi	mi								2023-	2023-06-08			
Contact Name	Title - Contact			1	Phone - Contact*				Emai	Email - Contact*			
Product-Env-Stewards	uct-Env-Stewards Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
uthorized Representative* Title - Representative				1	Phone - Representative*				Emai	Email - Representative*			
Product-Env-Stewards Product Enviro Compliance					NA				Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Ite	em Number	Mfr Item Name			Effective Date	e Version	]	Manufacturing Site		Weight*	UOM	Unit Type	
MC74	4HC367ADG IC BUFF/DVR TRI-		RI-ST HEX		2023-06-08 PH1		PH1		142.68	mg	Each		
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base Alloy J-S7		J-STD-020 MSL	Rating	Peak Process Body Tempera		'emperatu	ure Max Time at Peak Tempera		erature Nu	mber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy 1		1		260		С	30	see	conds 3				
Comments													
evel 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds											
For more information regarding material composition	n please refer to	p page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

select a ROHS exemption, if appli sigma range of distribution unless	otherwise noted).	it of the substance of the Pl	PM concentration	[F] Optionally enter the positive (+) and n	legative (-) tolerance in per	cent (Note: percer	it tolerance values are	expected to cover a 3
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.73	mg	Supplier	Silicon (Si)	7440-21-3		2.73	mg
Die Attach	4.85	mg	Supplier	Silver (Ag)	7440-22-4		3.6375	mg
			Supplier	Epoxy resins	129915-35-1		1.2125	mg
Lead Frame	75.92	mg	Supplier	Silver (Ag)	7440-22-4		0.7592	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1518	mg
			Supplier	Iron (Fe)	7439-89-6		1.9739	mg
			Supplier	Copper (Cu)	7440-50-8		73.035	mg
Mold Compound-Black	55.11	mg		Epoxy resin	proprietary data		2.7555	mg
			Supplier	Phenolic Resin	Proprietary Data		2.7555	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.1022	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2756	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		48.2213	mg
Plating	3.73	mg	Supplier	Tin (Sn)	7440-31-5		3.73	mg
Wire Bond - Cu	0.34	mg	Supplier	Copper (Cu)	7440-50-8		0.34	mg